**DESCRIPTION**

The INA105 is a monolithic Gain = 1 differential amplifier consisting of a precision op amp and on-chip metal film resistors. The resistors are laser trimmed for accurate gain and high common-mode rejection. Excellent TCR tracking of the resistors maintains gain accuracy and common-mode rejection over temperature.

The differential amplifier is the foundation of many commonly used circuits. The INA105 provides this precision circuit function without using an expensive precision resistor network. The INA105 is available in 8-pin plastic DIP, TO-99 surface-mount and TO-99 metal packages.
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PIN CONFIGURATIONS

**Top View**

![PIN CONFIGURATION DIAGRAM]

**TO-99**

- No Internal Connection
- Tab

**INA105AM**

**INA105BM**

Ref – In 
+ In

V– No Internal Connection

Output Sense

1 2 3 4 5 6 7 8

**Top View**

![PIN CONFIGURATION DIAGRAM]

**DIP/SOIC**

- No Internal Connection
- Ref

- – In

- + In

- V+

- Output

- Sense

1 2 3 4 5 6 7 8

**NOTE:** (1) Performance grade identifier box for small outline surface mount. Blank indicates K grade. Part is marked INA105U.

ABSOLUTE MAXIMUM RATINGS

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Specification</th>
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<tbody>
<tr>
<td>Supply</td>
<td>±18V</td>
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<tr>
<td>Input Voltage Range</td>
<td>±V in</td>
</tr>
<tr>
<td>Operating Temperature Range: M</td>
<td>–55°C to +125°C</td>
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<tr>
<td>P, U</td>
<td>–40°C to +85°C</td>
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<tr>
<td>Storage Temperature Range: M, U</td>
<td>–65°C to +150°C</td>
</tr>
<tr>
<td>Lead Temperature (soldering, 10s) M, P</td>
<td>–40°C to +125°C</td>
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<tr>
<td>Wave Soldering (3s, max) U</td>
<td>+300°C</td>
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<tr>
<td>Output Short Circuit to Common</td>
<td>+260°C</td>
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PACKAGE/ORDERING INFORMATION

<table>
<thead>
<tr>
<th>PRODUCT</th>
<th>PACKAGE</th>
<th>PACKAGE DRAWING NUMBER(1)</th>
<th>TEMPERATURE RANGE</th>
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<tbody>
<tr>
<td>INA105AM</td>
<td>TO-99 Metal</td>
<td>001</td>
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<tr>
<td>INA105BM</td>
<td>TO-99 Metal</td>
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<td>–40°C to +85°C</td>
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<td>8-Pin SOIC</td>
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**NOTE:** (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.
TYPICAL PERFORMANCE CURVES
At $T_A = 25^\circ C$, $V_S = \pm 15V$, unless otherwise noted.
APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the INA105. Power supply bypass capacitors should be connected close to the device pins.

The differential input signal is connected to pins 2 and 3 as shown. The source impedances connected to the inputs must be nearly equal to assure good common-mode rejection. A 5Ω mismatch in source impedance will degrade the common-mode rejection of a typical device to approximately 80dB. If the source has a known mismatch in source impedance, an additional resistor in series with one input can be used to preserve good common-mode rejection.

The output is referred to the output reference terminal (pin 1) which is normally grounded. A voltage applied to the Ref terminal will be summed with the output signal. This can be used to null offset voltage as shown in Figure 2. The source impedance of a signal applied to the Ref terminal should be less than 10Ω to maintain good common-mode rejection.

Do not interchange pins 1 and 3 or pins 2 and 5, even though nominal resistor values are equal. These resistors are laser trimmed for precise resistor ratios to achieve accurate gain and highest CMR. Interchanging these pins would not provide specified performance.

FIGURE 1. Basic Power Supply and Signal Connections.
For low source impedance applications, an input stage using OPA27 op amps will give the best low noise, offset, and temperature drift performance. At source impedances above about 10kΩ, the bias current noise of the OPA27 reacting with the input impedance begins to dominate the noise performance. For these applications, using the OPA111 or dual OPA2111 FET input op amp will provide lower noise performance. For lower cost use the OPA121 plastic. To construct an electrometer use the OPA128.

<table>
<thead>
<tr>
<th>$A_1$, $A_2$</th>
<th>$R_1$ (Ω)</th>
<th>$R_2$ (Ω)</th>
<th>GAIN (V/V)</th>
<th>CMRR (dB)</th>
<th>MAX $I_B$ (nA)</th>
<th>NOISE AT 1kHz (nV/√Hz)</th>
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<tr>
<td>OPA27A</td>
<td>50.5</td>
<td>2.5k</td>
<td>100</td>
<td>128</td>
<td>40nA</td>
<td>4</td>
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<tr>
<td>OPA111B</td>
<td>202</td>
<td>10k</td>
<td>100</td>
<td>110</td>
<td>1pA</td>
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<td>10k</td>
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<td>118</td>
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FIGURE 3. Precision Difference Amplifier.

FIGURE 5. Current Receiver with Compliance to Rails.
FIGURE 6. Precision Unity-Gain Inverting Amplifier.

FIGURE 7. ±10V Precision Voltage Reference.

FIGURE 8. ±5V Precision Voltage Reference.

FIGURE 9. Precision Unity-Gain Buffer.

FIGURE 10. Pseudoground Generator.

FIGURE 11. Precision Average Value Amplifier.
FIGURE 12. Precision (G = 2) Amplifier.

\[ V_0 = 2 \times V_1 \]
Gain Error = 0.01\% maximum
Gain Drift = 2ppm/°C

FIGURE 13. Precision Summing Amplifier.

\[ V_0 = V_1 + V_3, \pm 0.01\% \text{ maximum} \]

FIGURE 14. Precision Gain = 1/2 Amplifier.

\[ V_0 = V_3/2, \pm 0.01\% \]

FIGURE 15. Precision Bipolar Offsetting.

0 to +10V Output ±2ppm/°C

FIGURE 16. Precision Summing Amplifier with Gain.

\[ V_0 = \left(1 + \frac{R_3}{R_1}\right) \left(\frac{V_1 + V_3}{2}\right) \]

For G=10, See INA106.
FIGURE 17. Instrumentation Amplifier Guard Drive Generator.

FIGURE 18. Precision Summing Instrumentation Amplifier.

FIGURE 20. Differential Input Voltage-to-Current Converter for Low $I_{\text{OUT}}$.


FIGURE 23. Isolating Current Source with Buffering Amplifier for Greater Accuracy.
FIGURE 24. Window Comparator with Window Span and Window Center Inputs.

FIGURE 25. Precision Voltage-Controlled Current Source with Buffered Differential Inputs and Gain.

FIGURE 26. Digitally Controlled Gain of ±1 Amplifier.
FIGURE 27. Boosting Instrumentation Amplifier Common-Mode Range From ±5 to ±7.5V with 10V Full-Scale Output.

FIGURE 28. Precision Absolute Value Buffer.

FIGURE 29. Precision 4-20mA Current Transmitter.
### Packaging Information

<table>
<thead>
<tr>
<th>Orderable Device</th>
<th>Status</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>Package Qty</th>
<th>Eco Plan</th>
<th>Lead finish/Ball material</th>
<th>MSL Peak Temp (3)</th>
<th>Op Temp (°C)</th>
<th>Device Marking</th>
<th>Samples</th>
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<tbody>
<tr>
<td>INA105AM</td>
<td>LIFEBUY</td>
<td>TO-99</td>
<td>LMC</td>
<td>8</td>
<td>1</td>
<td>RoHS &amp; Green</td>
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<td>Samples</td>
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<td>-40 to 85</td>
<td>INA105U</td>
<td>Samples</td>
</tr>
</tbody>
</table>

(1) The marketing status values are defined as follows:
- **ACTIVE**: Product device recommended for new designs.
- **LIFEBUY**: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
- **NRND**: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
- **PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.
- **OBSOLETE**: TI has discontinued the production of the device.

(2) **RoHS**: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
- **RoHS Exempt**: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
- **Green**: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

**REEL DIMENSIONS**

- Reel Diameter
- Reel Width (W1)

**TAPE DIMENSIONS**

- K0: Dimension designed to accommodate the component thickness
- B0: Dimension designed to accommodate the component length
- A0: Overall width of the carrier tape
- P1: Pitch between successive cavity centers
- W: Width of the tape

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

- Pocket Quadrants
- Sprocket Holes
- User Direction of Feed

---

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width W1 (mm)</th>
<th>A0 (mm)</th>
<th>B0 (mm)</th>
<th>K0 (mm)</th>
<th>P1 (mm)</th>
<th>W (mm)</th>
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*All dimensions are nominal*
**TAPE AND REEL BOX DIMENSIONS**

*All dimensions are nominal*

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<th>Width (mm)</th>
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## TUBE

*All dimensions are nominal*

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